





48 V power management solution for Al servers

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Driving the evolution of power in server & communications infrastructure

Complete solution for direct/dual-stage power delivery in 48 V systems

conversion

Jual-stage

Powering datacenters with highest efficiency solution



1st stage 2nd stage Intermediate **b**us **c**onversion SPS **Multiphase digital controller** SPS **CPU** Unregulated SPS 48 V— **DDR** SPS **ASIC** Or SPS SPS Regulated SPS

Direct conversion

Resonant solution with isolation support





CPU



Dual stage conversion intermediate bus: 48 V to 12 V

3 topologies available based on customer needs for server and telecom 12 V bus distributions

Unregulated

98.2 % Efficiency

STC: switched tank converter

- Low profile solution (5 mm)
- High density 1 KW in 1/8 brick
- High efficiency

MP

STC digital controller STNRG328A VFQFPN32 5x5 mm

MP

Full bridge driver STPRDC02 VFQFPN 4x4 mm

Intel VR13.HC Reference design

STB digital controller PM6764

MP

Full bridge driver STPRDC02 VFQFPN 4x4 mm

Intel VR13.HC Intel VR14 Reference design

Regulated

98.4 % Efficiency

Unregulated

Flexible conversion ratio

98.5% Efficiency

STB: stacked buck converter

- Scalable solution
- High power capability above 3 kW
- ST patent

HSTC digital controller PM6780 VFQFPN 5x5 mm

MP

ST patent

MP

HSTC: hybrid switched tank converter

High power and high-density solution

Minimized BOM count for any ratio

Full bridge driver STPRDC02A VFQFPN 4x4 mm

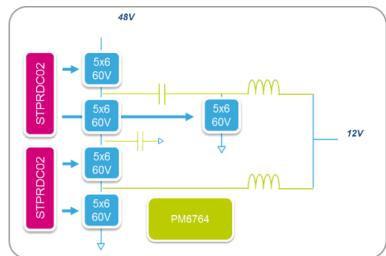
MP

VFQFPN28 4x4 mm



Main features

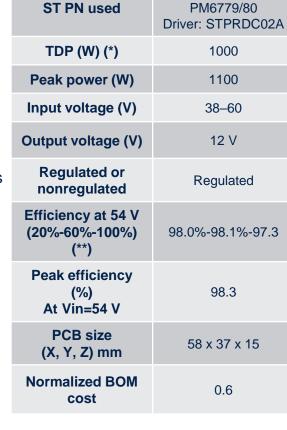
- · Regulated output, nonisolated
- Server and telecom 12 V bus distribution
- Input voltage: 38–60 V
- Output voltage: 12 V regulated (adjustable by PMBus)
- Thermal design power (TDP): 1000 W
- Coupled inductor for higher density and efficiency
- Digital controller PM6779/PM6780, STPRDC02/A drivers
- Total area: 58x37 mm (quarter brick)



STB-UCL 1 kW

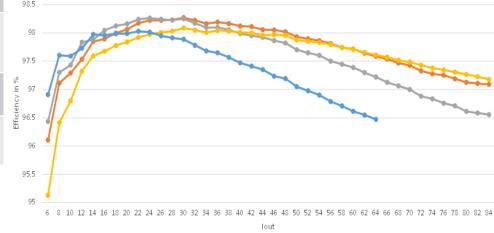
58 x 37 x 14 mm



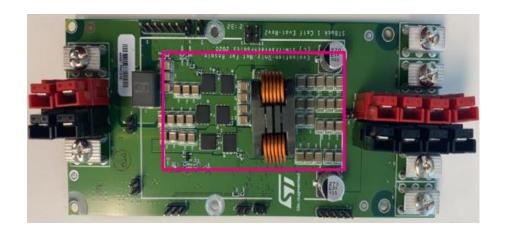


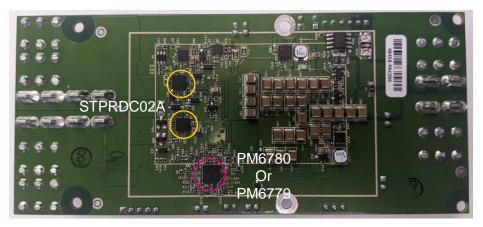
STB-UCL-1kW

Controller:









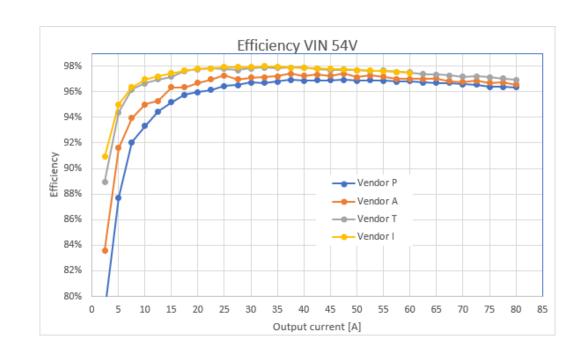
• 2 inductors qualified:

- Vendor I: max. 14.3 mm height
- Vendor T: max. 14 mm height
- Keep working with 2 more inductors vendors:
 - Vendor A: max. 16 mm height
 - Vendor P: max. 14 mm height
- 2 MOSFET vendors qualified

STB-UCL status

STB-UCL on-board solution is stable and validated:

- Topology already in production since 2Y in one customer
- Solution in qualification at >10 customers, completed at 2 customers
- Extensive bench validation (EBV) completed successfully
- Chamber tests 3 batches (8 boards each) completed successfully

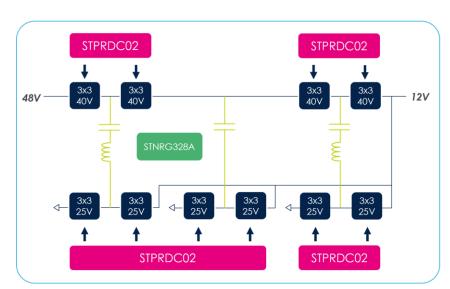






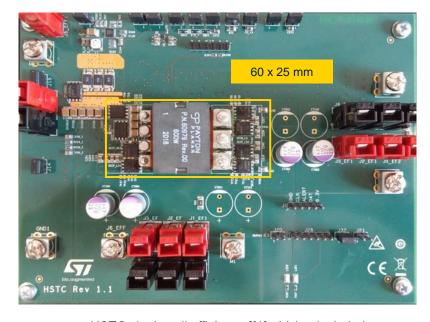
Main features

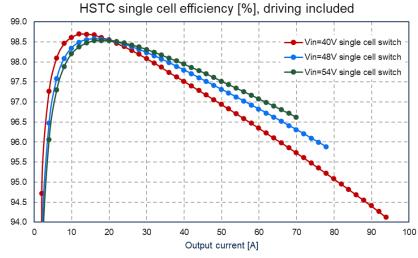
- Fixed conversion ratio
- Nonregulated output (4:1), nonisolated
- High-efficiency and low profile (5 mm)
- Input voltage: 40–60 V
- Thermal design power (TDP): 1000 W (1200 W peak)
- Digital controller STNRG328, STPRDC02/A drivers
- Total area: 65 x 55 mm (or 65 x 25 if dual-side PCB)



HSTC 750	
ST PN used	Controller: PM6779/80 Driver: STPRDC02A
TDP (W) (*)	750
Peak power (W)	900
Input voltage (V)	38-60
Output voltage (V)	5:1
Regulated or nonregulated	Non-Regulated
Efficiency at 54 V (20%-60%- 100%) (**)	98.4%-98%- 96.6%
Peak efficiency (%) At Vin=54 V	98.5
PCB size (X, Y, Z) mm	60x25x12.5
Normalized BOM cost	0.6

HSTC 750



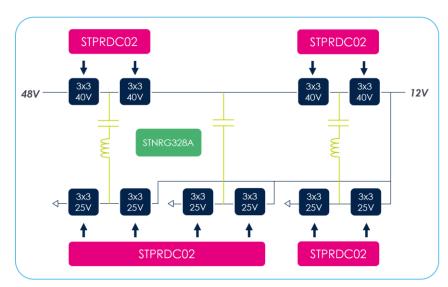






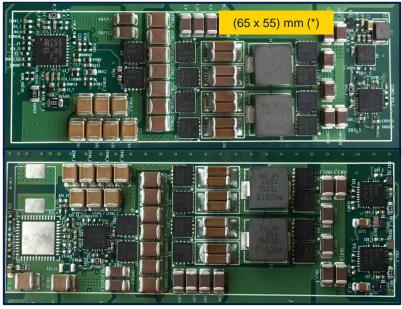
Main features

- Fixed conversion ratio
- Nonregulated output (4:1), nonisolated
- High-efficiency and low profile (5 mm)
- Input voltage: 40V-60V
- Thermal design power (TDP): 1000 W (1200 W peak)
- Digital controller STNRG328, STPRDC02/A drivers
- Total area: 65x55 mm (or 65x25 if dual side PCB)



STC U2J 1KW	
ST PN used	Controller: STNRG328 Driver: STPRDC02
TDP (W) (*)	1000
Peak power (W)	1200
Input voltage (V)	40-60
Output voltage (V)	4:1
Regulated or nonregulated	Non-Regulated
Efficiency at 54 V (20%-60%- 100%) (**)	97.35%-97.6- 96.4%
Peak efficiency (%) At Vin=54 V	97.9
PCB size (X, Y, Z) mm	65x55x6
Normalized BOM cost	1.2

STC U2J 1KW



(*) PCB area equivalent moving from "double side" to "single side" component mounting

STC 1kW 1/8 Brick Efficiency Total efficiency with bias 100.00% 99.00% 98.00% 97.00% 96.00% 95.00% **−**58Vin 94.00% 93.00% **40Vin** 92.00% 91.00% 90.00% 80 20 100 Load Current (A)



54 V solutions: BOM cost roadmap

Unregulated solution

Regulated solution



ST is committed to reducing total BOM cost And increasing the overall system performance







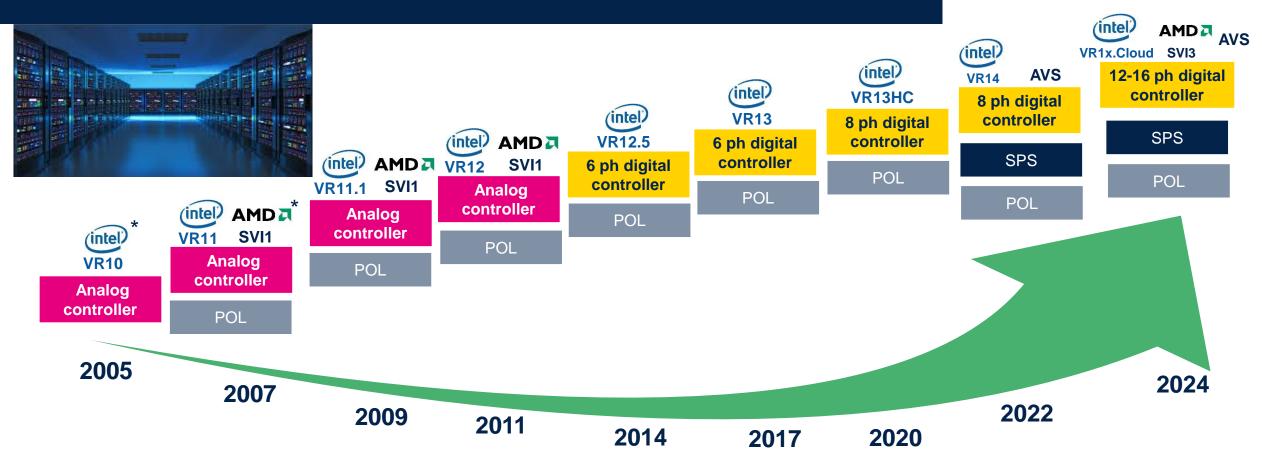






Dual stage conversion second stage: 12 V to CPU/DDR/ASIC

Major experience in 12 V solutions for INTEL/AMD CPU/DDR and SoC





Total solution VR14 complaint

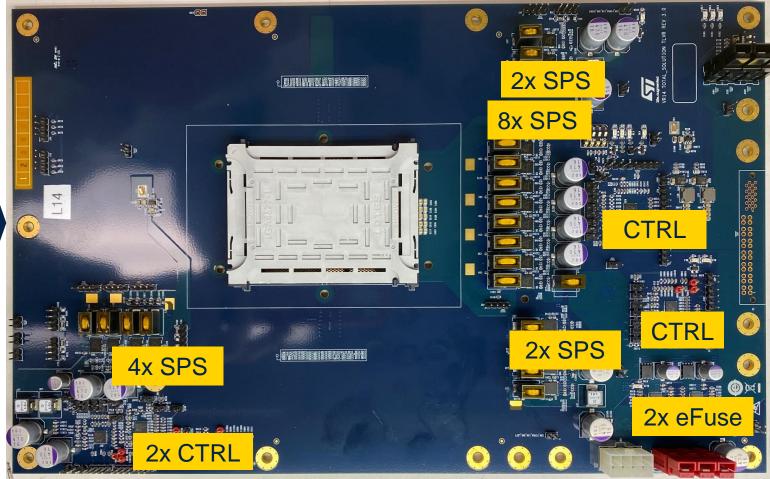
Example of 48 V → 12 V → load ST Total solution

12 V → load conversion





ST components on bottom side: controller, driver, MOSFET; eFuse coming





ST components: Controller, SPS, eFuse

Our technology starts with You



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